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(Rev. 10/02)		Z	U.S. Patent and Trademark Office					
To the Director of the U.S. rates, and 103152	067	ettached asiginal	commonts or committee					
1. Name of conveying party(ies):			ocuments or copy thereof.					
Kim Yong GOH	2. Name and address of receiving party(ies): UNITED TEST AND ASSEMBLY CENTER LTD.							
Rahul KAPOOR	5 Serangoon North Avenue 5, Singapore 554916							
-Anthony Yi-Sheng SUN			· .					
Desmond Yok Rue CHONG	Xilinx, Inc.	0.1.00						
Lan H. HOANG	2100 Logic Driv	ve, San Jose, Calif	fornia 95124					
	1							
Additional name(s) of conveying party(ies) attached? ☐ Yes ☑ No								
3. Nature of conveyance:								
☑ Assignment ☐ Merger								
☐ Security Agreement ☐ Change of Name								
□ Other	_							
Execution Date: January 30, 2004, January 30, 2004, January 30, 2004, January 30, 2004, and February 3, 2004	Additional name(s	s) & address(es) atta	ached? 🗆 Yes 🗹 No					
4. Application number(s) or patent number(s):								
If this document is being filed together with a new applica January 30, 2004, January 30, 2004, January 30, 2004, and A. Patent Application No.(s) Not Yet Assigned  Additional numbers a	B. Patent No. Unknown	1	cation is: January 30, 2004,					
5. Name and address of party to whom correspondence			nd patents involved:					
concerning document should be mailed:			1					
SUGHRUE MION, PLLC	7. Total fee (37	CFR 3.41):	\$40.00					
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Alan J. Kasper Reg. No.	25,426		Date					
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Alexandria, VA 22313-1450

**PATENT** 

REEL: 017413 FRAME: 0842

## Assignment

Whereas, I/We. Kim Yong GOH, Rahul KAPOOR, Anthony Yi-Sheng SUN and Desmond Yok Rue CHONG, all c/o United Test and Assembly Cemer Ltd., 5 Serangoon North Avenue 5, Singapore 554916, hereinafter called assignor(s), have invented certain improvements in MOLDED HIGH DENSITY ELECTRONIC PACKAGING STRUCTURE FOR HIGH PERFORMANCE APPLICATIONS and executed an application for Letters Pasent of the United States of America therefor on \_\_\_\_\_\_\_; and

Whereas, UNITED TEST AND ASSEMBLY TEST CENTER LTD., 5 Serangoon North Avenue 5, Singapore 554916 (assignee), desires to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

I/We, the above named assignor(s), hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America and all countries foreign thereto, including rights of priority under the International Convention of Paris (1883) as amended, and I/we request the Director of the U.S. Parent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and I/we hereby agree that the assignee may apply for foreign Letters Patent on the invention and I/we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States and foreign applications when called upon to do so by the assignee.

		authorize and request our attorneys SUGHRUE MION, PLLC of 2: te, NW, Washington, DC 20037-3213 to insert here in parentheses and Confirmation number Not Yet Assigned,	
~ -FF-		) the application number and filing date of said application when k	
Date:	1/30/04	Colling	
Date:	1/30/04	SKim Yong GOFI Och Yoft	
Date:	1/3/04	s/Rahui Kapoor	
Date:	1/20/04	S/Anthony Yi-Shong SUN  Charles Charles  S/Der Wood Yells CHONG	

(Legalization not required for recording but is prima facle evidence of execution under 35 U.S.C. §261)

~?oo'₽

30/01 2004 19:02 FAX 65 65511155

Signed in Counterpart

## ASSIGNMENT

Docket No. X-1626 US

For good and valuable consideration, receipt of which is hereby acknowledged, I/we

of 38848 Bell Street, Fremont, CA 94536

hereby sell, assign and transfer to Xilinx, Inc., a Delaware corporation, having a place of business at 2100 Logic Drive, San Jose, California 95124, its successors and assigns, the entire right, title and interest throughout the world in our invention

## MOLDED HIGH DENSITY ELECTRONIC PACKAGING STRUCTURE FOR HIGH PERFORMANCE APPLICATIONS

for which I/we will execute a United States patent application on or about the date of this assignment, and all patent applications and patents of every country for said invention, including divisions, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said applications; I/we authorize the above-named assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from me/us; I/we agree to execute all papers useful in connection with said United States and foreign applications, and generally to do everything possible to aid said assignee, its successors, assigns and nominees, at its request and expense, in obtaining and enforcing patents for said invention in all countries; and I/we request the Commissioner of Patents and Trademarks to issue all patents granted for said invention to the abovenamed assignee, its successors and assigns.

Executed this 3rd day of Pe MILANI

CAPACITY CLAIMED BY SIGNER

[X] oneself/themselves

State of California County of Santa Clara

2, 2004 before me, Pat Slaback, Notary Public, personally Lan H. Hoang \_\_ [ ] personally known to me -or - [X] proved to me on the basis of satisfactory evidence to be the person whose name is subscribed to the within instrument and acknowledged to me that he/she executed the same in his/her authorized capacity, and that by his/her signature on the instrument the person, or the entity upon behalf of which the person acted, executed the instrument.

WITNESS my hand and official seal.

RECORDED: 07/26/2005

KK:pbs

PATENT REEL: 017413 FRAME: 0844